


General

- Slow Blow
- 3.10mm× 1.55mm physical size
- Thick film manufacturing method, ceramic substrate, silver fusing element
- -55℃~125℃ operating temperature
- Excellent environmental integrity
- RoHS compliant
- Halogen-free
- Lead free

Agency / Certificate Information

Agency	File Number	Ampere Range
	E319512	0.5A~7A

Application

- Battery pack
- PC related equipment and peripherals (Hard driver, Printer, etc.)
- Digital camera (Digital still camera)
- Game equipment
- LCD monitor, LCD modules
- Wireless base station
- Power supply
- Medical device

Electrical Specifications

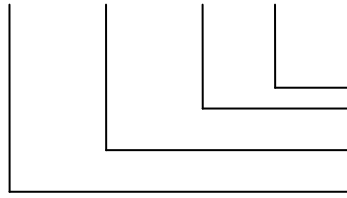
Part Number	Marking	Current Rating (A)	Voltage Rating (V)	Interrupting Rating (V)	Typical Cold DCR* (mΩ)	Typical I ² T** (A ² s)
S1206-S-0.5A	F	0.5	32	50A 32V DC	1200	0.0075
S1206-S-0.75A	G	0.75	32		540	0.0169
S1206-S-1.0A	H	1.0	32		320	0.1945
S1206-S-1.5A	K	1.5	32		140	0.4137
S1206-S-2.0A	N	2.0	32		92	0.4383
S1206-S-2.5A	O	2.5	32		65	0.7343
S1206-S-3.0A	P	3.0	32		36	1.5267
S1206-S-3.5A	R	3.5	32		30	1.5312
S1206-S-4.0A	S	4.0	32	35A 32V DC	23	2.5356
S1206-S-5.0A	T	5.0	32		16	3.3999
S1206-S-6.0A	6	6.0	32		12.5	5.7505
S1206-S-7.0A	U	7.0	32		7.0	8.8200

* Measured at ≤10% rated current and 25℃

** Melting I²T at 10 times of rated current

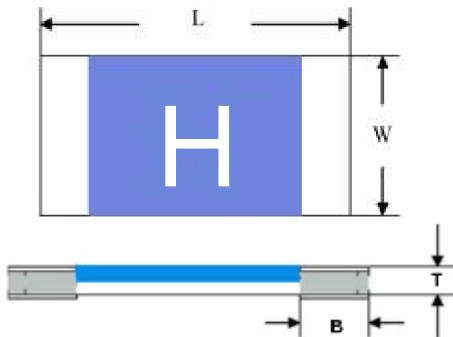
Part Number Information

S 1206-S-1.0A



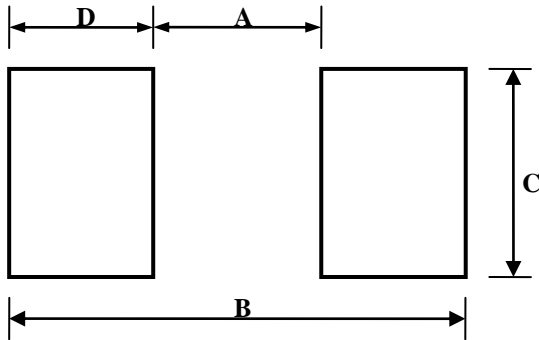
- “1.0A” Ampere Rating: 1A
- “S” Electrical Characteristic: S = Slow Blow
- “1206” Size Number
- “S” Symbol of SART

Dimensions



Type	L (mm)	W (mm)	T (mm)	B (mm)
S1206-S	3.10±0.20	1.55±0.20	0.55±0.20	0.50±0.20

Recommended Land Patterns



Dimensions	A(mm)	B(mm)	C(mm)	D(mm)
Spec	2.00±0.30	4.40±0.50	2.40±0.30	1.20±0.30

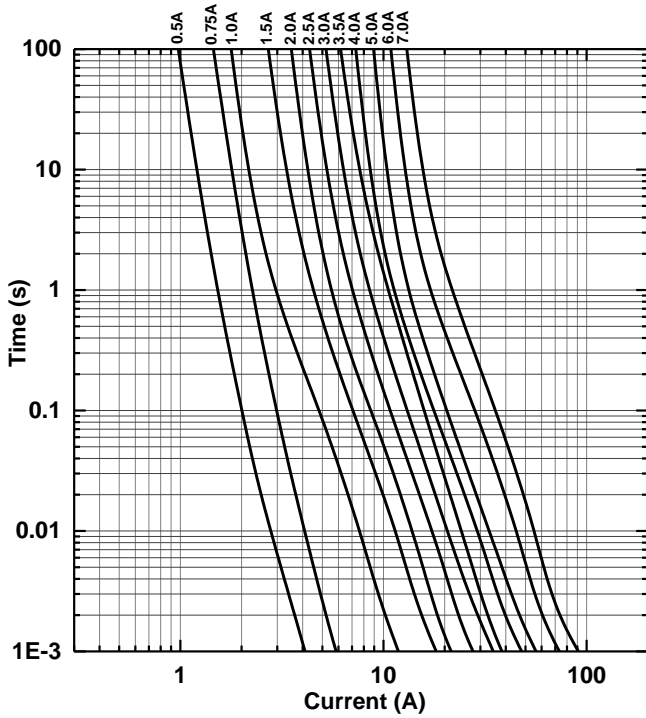
Materials

Components	Material
Body	Ceramic
Terminations	Silver over plated with tin (100%)
Element	Silver or Silver/Palladium

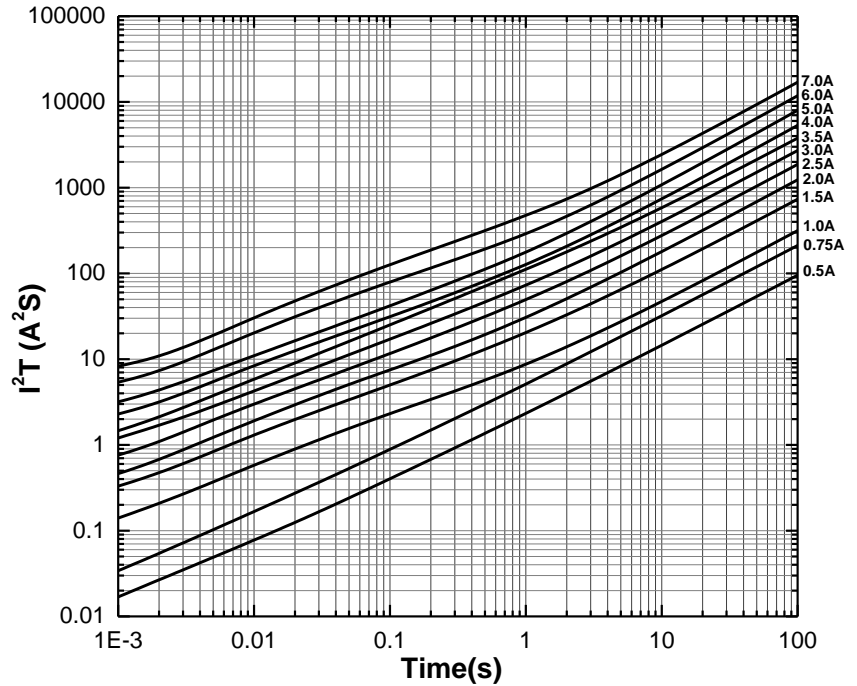
Dimensions of Standard Test Board

Type	Ampere Rating	Board Thickness (mm)	Copper Layer Thickness (mm)	Copper Trace Width (mm)
S1206-S	0.5A~6.0A	1.6	0.035	5.0
	7.0A	1.6	0.070	7.5

Time Current Curve



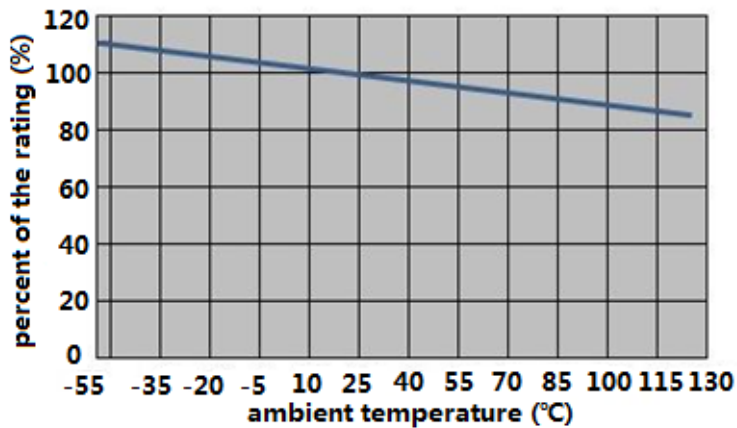
I²T VS Time Curve



Electrical Characteristics

Type	Ampere Rating	% of Current Rating	Opening Time
S1206-S	0.5A~7.0A	100	>4hours
	1.0A~7.0A	200	≤60sec
	0.5A~0.75A	250	≤20sec
	0.5A~0.75A	1000	>0.1ms
	1.0A~7.0A	1000	>1.0ms

Temperature Derating Curve



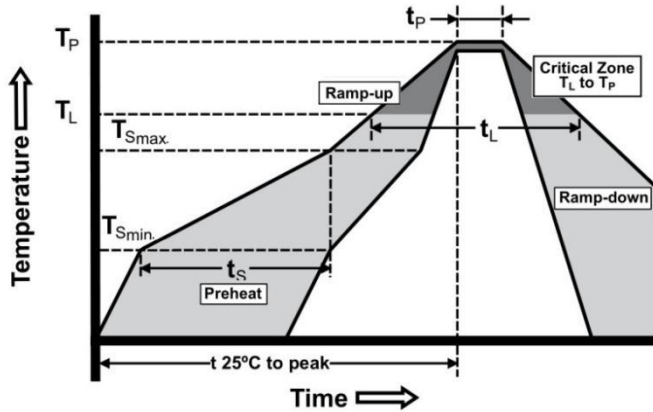
Product Characteristics

Item	Test condition/ Methods	Performance	Standard
Time/Current	100% of current rating	No Fusing, 4hours Min.	UL248-14
	200% of current rating	1.0A~7.0A: ≤60sec	SART SPEC.
	250% of current rating	0.5A~0.75A: ≤20sec	
	1000% of current rating	0.5A~0.75A: >0.1ms 1.0A~7.0A: >1.0ms	IEC60127-4
Voltage Drop	100% of current rating	Deviation between the mean value: <15%	IEC60127-4
Temperature Rise	100% of current rating	ΔT<75°C	IEC60127-4
Endurance Test	100 cycles of 1In for 1h “ON”, for 15min “OFF”, then following by 1h of 125%In	ΔR :<10%	IEC60127-4
Interrupting Ability	0.5A~3.5A: 50A 32V DC 4.0A~7.0A: 35A 32V DC	without permanent arcing, ignition and bursting of fuse link	UL248-14 IEC60127-4
Solderability	240°C±5°C, 3sec±0.5sec	95% coverage Min.	IEC60127-4 MIL-STD-202 Method 208
Resistance to Soldering	260°C±5°C, 10sec±0.5sec	ΔR :<10% Legible appearance	MIL-STD-202 Method 210
Bending Test	Distance between holding points: 90mm Bending: 1mm, time: 10sec	ΔR :<10% No mechanical damages	IEC60127-4
High Temperature Operating Life	T=70°C±2°C, 60%In, 96hours	ΔR : <10%; No fusing	MIL-STD-202 Method 108
Humidity (Steady State)	T=40°C±2°C, 90%~95%RH, 1000hours	ΔR : <10%	MIL-STD-202 Method 103
Low Temperature Storage	T=-55°C±3°C, 96hours	ΔR : <10%	IEC60068-2-1
High Temperature Storage	T=125°C±2°C, 96hours	ΔR : <10%	IEC60068-2-2
Salt Spray	5% salt solution, 48hours	ΔR : <10% Legible appearance	MIL-STD-202 Method 101
Thermal Shock	100 cycles between -65°C/+125°C 60 minutes, each extreme	ΔR : <10% No mechanical damages	MIL-STD-202 Method 107

Recommended Solder Curve

1. Infrared Reflow:

- Temperature: 260°C
- Time: 5sec Max.
- Recommend Reflow profile



Profile Feature	Pb-Free Assembly
Average Ramp-up Rate($T_{S_{max}}$ to T_p)	3°C/sec Max.
Preheat Temperature Min. ($T_{S_{min}}$)	150°C
Temperature Max. ($T_{S_{max}}$)	200°C
Time ($T_{S_{min}}$ to $T_{S_{max}}$)	60sec~120sec
Peak Temperature (T_p)	260°C
Time within 5°C of actual Peak Temperature (T_p)	5sec
Melting tin time (T_L)	20sec~30sec
Ramp-down Rate	6°C/sec Max.
Time 25°C to peak Temperature	8minutes Max.

2. Wave soldering

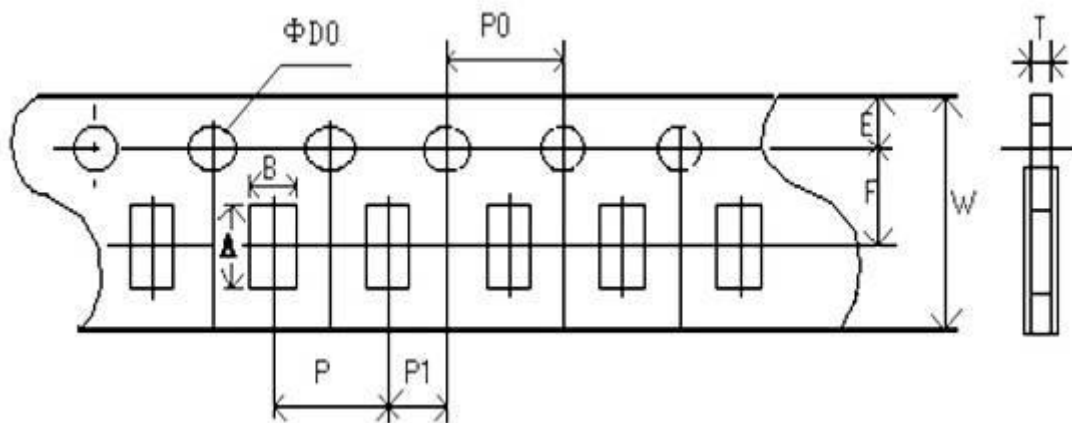
- Reservoir Temperature: 260°C
- Time in Reservoir: 10secMax.

3. Hand Soldering

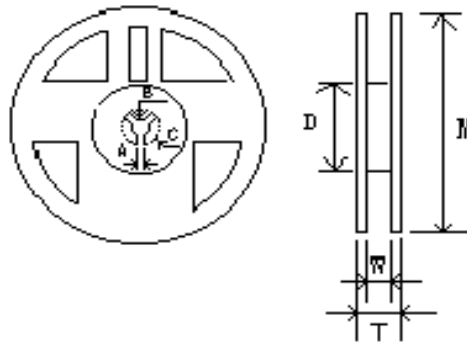
- Temperature: 350°C
- Time: 5secMax.

Packaging

- 5000 pieces of fuses in emboss taper and reeled on a 178mm(7 inch) reel.



Type	A(mm)	B(mm)	W(mm)	E(mm)	F(mm)
Spec	3.50±0.20	1.90±0.20	8.00±0.20	1.75±0.10	3.50±0.05
Type	P(mm)	P0(mm)	P1(mm)	D0(mm)	T(mm)
Spec	4.00±0.10	4.00±0.10	2.00±0.05	1.50±0.10	0.75±0.10



Type	M(mm)	W(mm)	T(mm)	A(mm)	B(mm)	C(mm)	D(mm)
Spec	178.00±2.00	9.50±1.00	12.50±1.50	2.00±0.50	13.00±0.50	21.00±0.50	58.00±2.00

Storage

- The ambient temperature recommended for storage shall be between 5°C~30°C
- The relative humidity recommended for storage shall be between 25%RH~60%RH
- Sealed plastic bags with desiccant shall be used to reduce the oxidation of the termination and shall only be opened prior to use
- The products shall not be stored in areas where harmful gases containing sulfur or chlorine are present

单击下面可查看定价，库存，交付和生命周期等信息

[>>SART\(萨特\)](#)